



v01.0407



# HMC615LP4 / 615LP4E

## GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 2.3 - 4.0 GHz

### Typical Applications

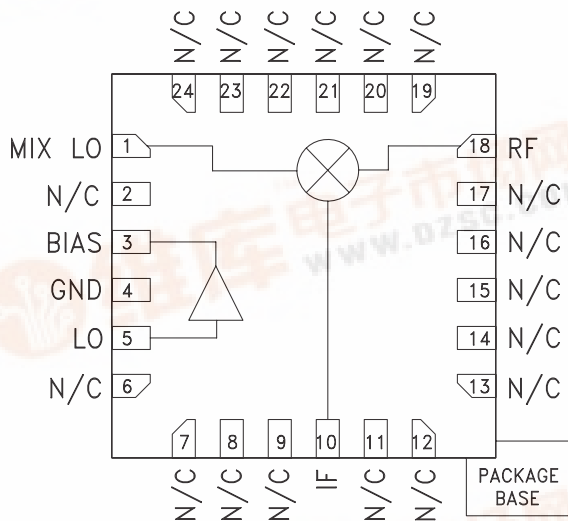
The HMC615LP4E is ideal for:

- PCS / 3G Infrastructure
- Base Stations & Repeaters
- WiMAX & WiBro
- ISM & Fixed Wireless

### Features

- High Input IP3: +35 dBm
- Low Input LO Drive: -2 to +6 dBm
- Low Conversion Loss: 10 dB
- Single Positive Supply: +5V @ 65 mA
- RoHS Compliant 4x4 mm QFN Package

### Functional Diagram



### General Description

The HMC615LP4(E) are high linearity, GaAs FET converter ICs that operate from 2.3 to 4.0 GHz and deliver a +35 dBm input third order intercept point. The LO amplifier output and high dynamic range mixer input are positioned so that an external LO filter can be placed in series between them. The IC operates from a single +5V supply consuming 65 mA of current and accepts a LO drive level of -2 to +6 dBm. The design requires no external baluns and supports IF frequencies between DC and 1 GHz. The HMC615LP4(E) is pin for pin compatible with the HMC551LP4(E), HMC552LP4(E) and HMC215LP4(E), which operate from 0.8 to 4.0 GHz. For availability on Non-RoHS HMC615LP4 products please contact Hittite Microwave sales directly.

### Electrical Specifications, $T_A = +25^\circ C$ , LO = 4 dBm, Vcc = +5V, IF = 200 MHz\*

Parameter	Min.	Typ.	Max.	Units
Frequency Range, RF, LO	2.3 - 4.0			GHz
Frequency Range, IF	DC - 1.0			GHz
Conversion Loss *		10	13	dB
Noise Figure (SSB)		10		dB
LO to RF Isolation	5	15		dB
LO to IF Isolation *	1	10		dB
IP3 (Input)		35		dBm
1 dB Compression (Input)		21		dBm
LO Drive Input Level (Typical)	-2 to +6			dBm
Supply Current (Icc)		65	75	mA

\*Unless otherwise noted, all measurements performed as a downconverter configured as shown in application circuit.





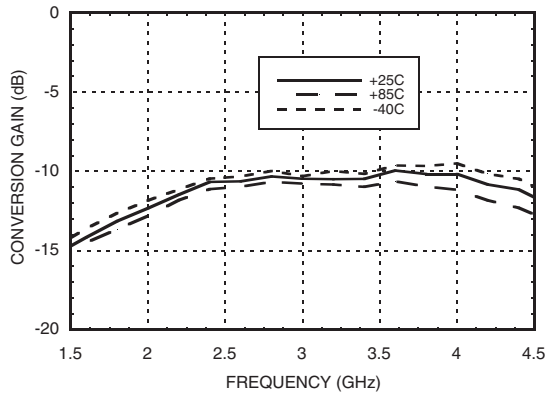
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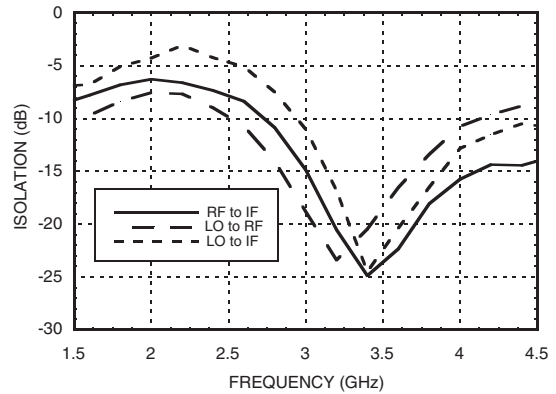
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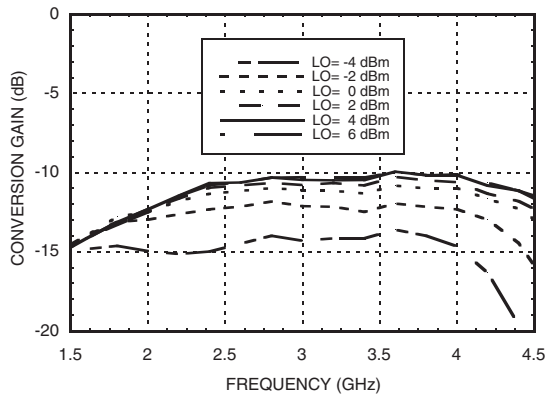
**Conversion Gain vs. Temperature @ LO = 4 dBm**



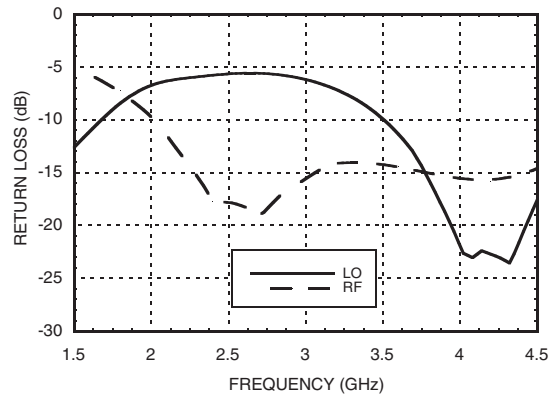
**Isolation @ LO = 4 dBm**



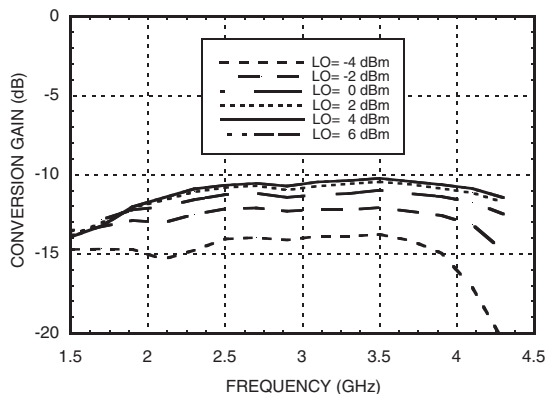
**Conversion Gain vs. LO Drive**



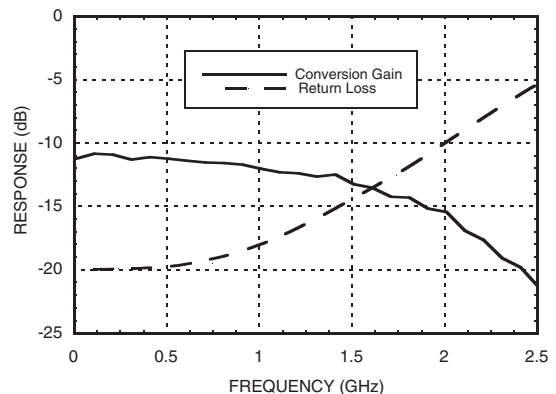
**Return Loss @ LO = 4 dBm**



**Upconverter Performance (IF= 100 MHz)  
Conversion Gain vs. LO Drive**



**IF Bandwidth @ LO = 4 dBm**





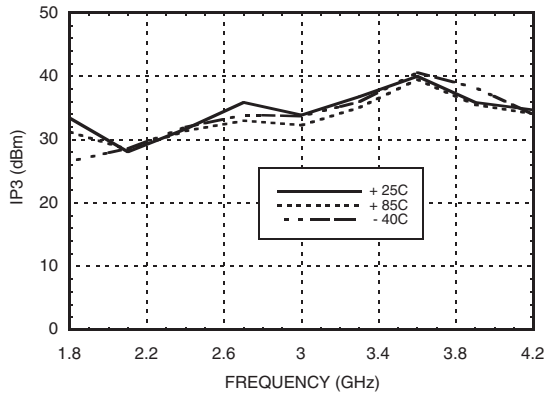
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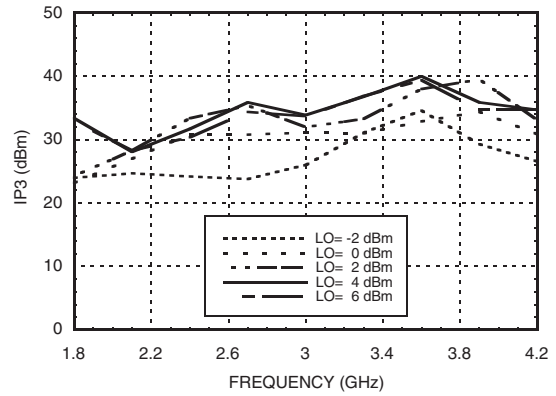
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## GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 2.3 - 4.0 GHz

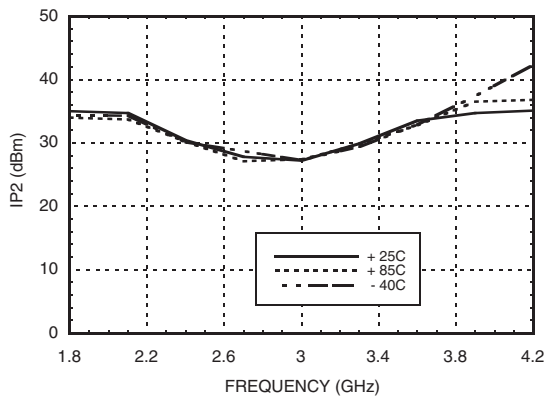
Input IP3 vs. Temperature @ LO = 4 dBm



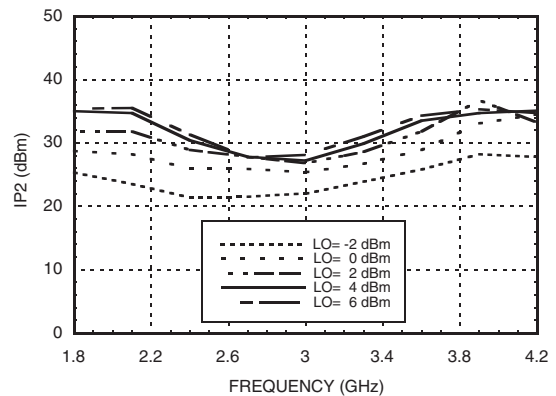
Input IP3 vs. LO Drive



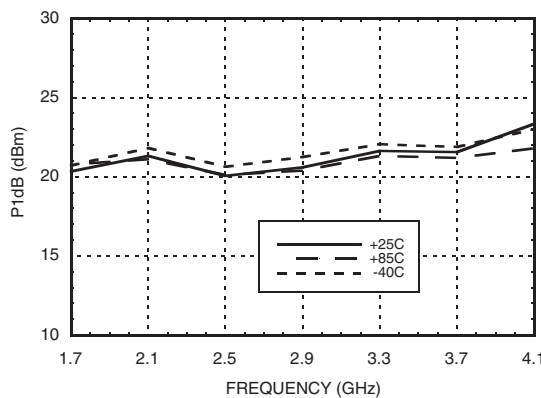
Input IP2 vs. Temperature @ LO = 4 dBm



Input IP2 vs. LO Drive



Input P1dB vs. Temperature @ LO = 4 dBm





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## HMC615LP4 / 615LP4E

### GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 2.3 - 4.0 GHz

#### MxN Spurious @ IF Port

mRF	nLO				
	0	1	2	3	4
0	xx	-11	-1	6	10
1	5	0	16	37	36
2	58	67	55	51	60
3	98	102	103	82	91
4	99	99	104	106	107

RF Freq. = 3 GHz @ -10 dBm  
 LO Freq. = 2.8 GHz @ 0 dBm  
 All values in dBc relative to the IF power level.

#### Harmonics of LO

LO Freq. (GHz)	nLO Spur @ RF Port			
	1	2	3	4
1	8	13	29	31
1.8	5	23	18	34
2.6	11	12	27	30
3.4	15	16	48	27
4.2	7	18	27	27
5	16	27	38	43

LO = 0 dBm  
 All values in dBc below input LO level measured at RF port.

#### Typical Supply Current

Vcc	Icc (mA)
+5.0	62 mA



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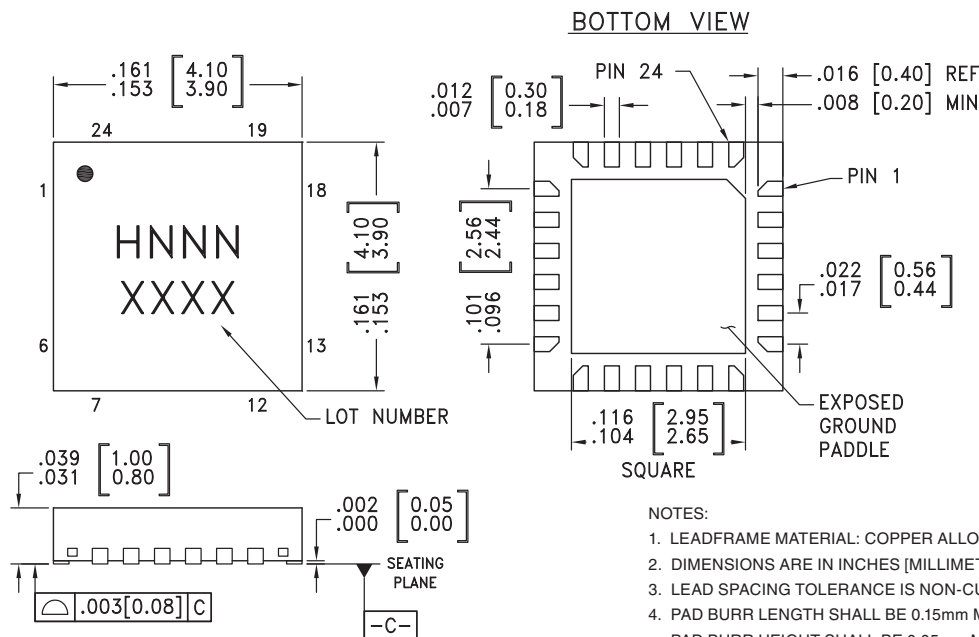
### Absolute Maximum Ratings

RF / IF Input (Vcc= +5V)	+27 dBm
LO Drive (Vcc= +5V)	+10 dBm
BIAS	+7 Vdc
Junction Temperature	150°C
Continuous Pdiss (T = 85°C) (derate 5.21 mW/°C above 85°C)	0.339 W
Thermal Resistance (junction to ground paddle)	192 °C/W
Storage Temperature	-65 to +150°C
Operating Temperature	-40 to +85°C



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

### Outline Drawing



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.  
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC615LP4	Low Stress Injection Molded Plastic <sup>[4]</sup>	Sn/Pb Solder	MSL1 <sup>[1]</sup>	H615 XXXX
HMC615LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	H615 XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

[4] For availability of Non-RoHS HMC615LP4 products please contact Hittite Microwave sales directly.

For price, delivery, and to place orders, please contact Hittite Microwave Corporation:  
20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373  
Order On-line at [www.hittite.com](http://www.hittite.com)



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# HMC615LP4 / 615LP4E

## GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 2.3 - 4.0 GHz

### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	MIX LO	This pin is DC coupled and matched to 50 Ohms. An off chip DC blocking capacitor is required.	
2, 6 - 9, 11 - 17, 19 - 24	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
3	BIAS	Power supply for the LO amplifier. Three external bypass capacitors are recommended for optimum performance, as illustrated in the application circuit.	
4	GND	Backside of package has exposed metal ground paddle that must also be connected to ground.	
5	LO	This pin is DC coupled and matched to 50 Ohms. An off chip DC blocking capacitor is required.	
10	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 18 mA of current or die non-function and possible die failure will result.	
18	RF	This pin is DC coupled and matched to 50 Ohms.	



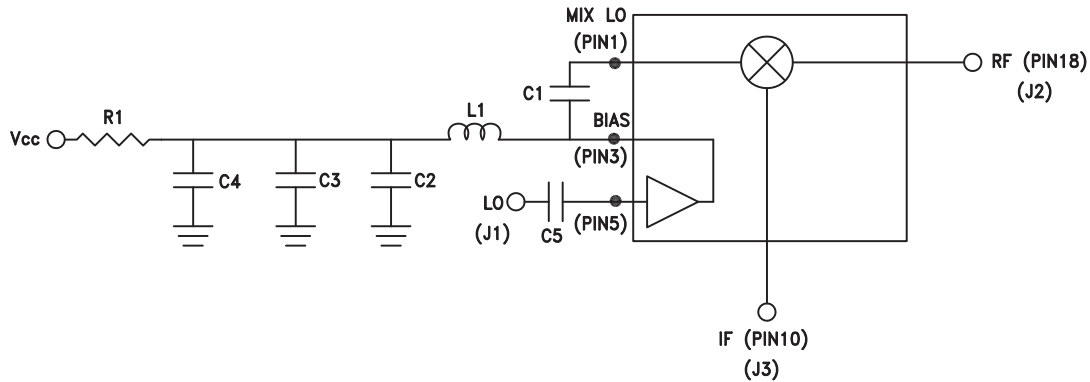
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**GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 2.3 - 4.0 GHz**

## Application Circuit



Recommended Components Values (IF = DC - 300 MHz)

C3	1000 pF
C4	2.2 $\mu$ F
C1, C2, C5	100 pF
L1	18 nH
R1	18 Ohm



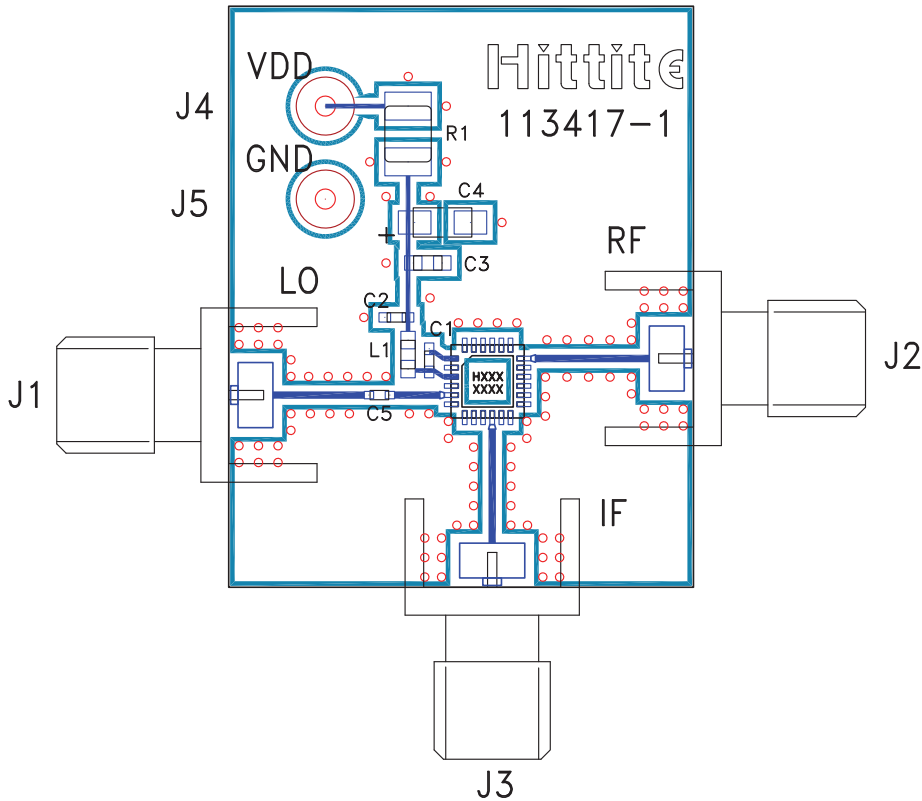
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# HMC615LP4 / 615LP4E

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## Evaluation PCB



### List of Materials for Evaluation PCB 113722 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
J4, J5	DC Pin
C1, C2, C5	100 pF Chip Capacitor, 0402 Pkg.
C3	1000 pF Chip Capacitor, 0603 Pkg.
C4	2.2 μF Capacitor, Tantalum
L1	18 nH Chip Inductor, 0603 Pkg.
R1	18 Ohm Resistor, 1210 1/8 watt Pkg.
U1	HMC615LP4E
PCB [2]	113417 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



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